<b>PCN Number:</b> 202305220			006	1	PCN Date:		May 23, 2023	
Title: Datasheet for THS402x			550.	<u> </u>	i chi ba		i iuy i	
					Quality Services			
Proposed 1 <sup>st</sup> Ship Date: Aug. 2				2022				Quality Services
	le.	Aug.	22,	2023				
Change Type:           Assembly Site				Design			Wafar	Bump Site
Assembly Process				Data Sheet		$\exists$		Bump Material
Assembly Material				Part number cha	nae			Bump Process
Mechanical Specif				Test Site	lige	$\exists$		Fab Site
Packing/Shipping/				Test Process		Η		Fab Materials
	Labelli	ig		1000035		Π		Fab Process
			Ν	otification Det	tails		Warer	1401100000
<b>Description of Chang</b>	e:							
Texas Instruments Inc		ted is	ann	ouncing an inform	ation only	not	ificatior	۱.
The product datashee						-		
•		0	•					
TEXAS INSTRUMENTS								THS4021, THS4022
						S265D	- SEPTEMB	ER 1999 – REVISED MAY 2023
Changes from Revisio								Page
								locument1
Added the Application     Configuration and Fu				pplication and implen haracteristics: THS40				
								ation sections1
<ul> <li>Changed data sheet</li> </ul>								
								1
								6
								rification6
								240 mA6 ± 4 V to ± 1.5 V6
				0, $V_{CC} = \pm 15$ V from				
Characteristics: THS	Characteristics: THS4021 (D Package)					8		
<ul> <li>Changed small-signa</li> </ul>	<ul> <li>Changed small-signal bandwidth at G = 10, V<sub>CC</sub> = ± 5 V from 280 MHz to 250 MHz in <i>Electrical</i></li> </ul>							
Characteristics: THS4021 (D Package)								
<ul> <li>Changed small-signal bandwidth at G = 20, V<sub>CC</sub> = ± 15 V from 80 MHz to 110 MHz in <i>Electrical</i></li> <li>Characteristics: THS4021 (D Package)</li> </ul>								
<ul> <li>Characteristics: THS4021 (D Package)</li></ul>								
Characteristics: THS4021 (D Package)								
	<ul> <li>Changed full power bandwidth calculation from slew rate / [2 πV<sub>O(Peak)</sub>] to slew rate / [πV<sub>O(P-P)</sub>] in <i>Electrical</i></li> </ul>							
Characteristics THS	<ul> <li>Characteristics THS4021 (D Package) table note</li></ul>							
<ul> <li>MHz to match calcula</li> <li>Changed full power b</li> </ul>								8 from 11.8 MHz to
-					•			8
	<ul> <li>Changed slew rate condition in <i>Electrical Characteristics: THS4021 (D Package)</i> from a 10-V step to a 20-V step for V<sub>CC</sub> = ±15 V</li></ul>							

•	Changed 0.1% settling time specification in Electrical Characteristics: THS4021 (D Package) from 40 ns to
	$30 \text{ ns for } V_{CC} = \pm 15 \text{ V}$
•	Changed 0.1% settling time specification in Electrical Characteristics: THS4021 (D Package) from 50 ns to
	30 ns for $V_{CC} = \pm 5 V_{CC}$
•	Changed 0.01% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 145 ns to 160 ns for $V_{CC} = \pm 15 \text{ V}$
•	Changed 0.01% settling time specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 155 ns to 160 sn for $V_{CC} = \pm 5 V$
•	Changed input current noise specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 1.5 pA/ √Hz to 1.2 pA/√Hz
•	Changed input current noise specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 1.2 pA/ √Hz to 2.3 pA/√Hz
•	Changed open-loop gain load condition in <i>Electrical Characteristics:</i> THS4021 (D Package) from 250 $\Omega$ to 1
•	$k\Omega$ for V <sub>CC</sub> = ± 5 V
•	Changed open-loop gain units from V/mV to dB in <i>Electrical Characteristics: THS4021 (D Package)</i>
•	Changed open-loop gain typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 35 mV/V to 98 dB for $V_{CC} = \pm 5$ V, $T_A = 25^{\circ}$ C
•	Changed input offset voltage typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 0.5 mA to 0.3 mA for 25°C
•	Changed offset voltage drift typical specification in <i>Electrical Characteristics: THS4021 (D Package)</i> from 15 μA/°C to 2 μA/°C
•	Changed input bias current typical in <i>Electrical Characteristics THS4021 (D Pacakge)</i> from 3 $\mu$ A to 9 $\mu$ A for $T_A = 25^{\circ}$ C
•	Changed input bias current maximum value in <i>Electrical Characteristics THS4021 (D Package)</i> from 6 $\mu$ A to 20 $\mu$ A for T <sub>A</sub> = 25°C
•	Changed input bias current maximum value in <i>Electrical Characteristics THS4021 (D Package)</i> from 8 $\mu$ A to 33 $\mu$ A for T <sub>A</sub> = full range
•	Changed input offset current drift typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 0.3 nA/°C to 0.2 nA/°C
•	Added Common-mode rejection ratio typical in <i>Electrical Characteristics: THS4021 (D Package)</i> for 25°C8
•	Added common-mode rejection ratio in <i>Electrical Characteristics: THS4021 (D Package)</i> for VCC = ± 5 V8
•	Changed output voltage swing typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from $\pm$ 12.5 V to $\pm$ 12.9 V for V <sub>CC</sub> = $\pm$ 15 V, R <sub>L</sub> =250 $\Omega$
•	Changed output current load resistance typical value in <i>Electrical Characteristics THS4021 (D Package)</i> from 20 $\Omega$ to 10 $\Omega$ .
•	Changed output current typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 100 mA to 200 mA for $V_{CC} = \pm 15$ V
•	Changed output current typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 75 mA to 160 mA for $V_{CC} = \pm 5 V$
	Changed output resistance in <i>Electrical Characteristics:</i> THS4021 (D Package) from 13 $\Omega$ to 5 $\Omega$
•	Changed supply current (each amplifier) typical value in <i>Electrical Characteristics: THS4021 (D Package)</i>
-	from 7.8 mA to 7.5 mA for $V_{CC} = \pm 5 V$
•	Changed supply current (each amplifier) typical value in <i>Electrical Characteristics: THS4021 (D Package)</i> from 6.7 mA to 6.5 mA for $V_{CC} = \pm 5 V$
•	Added power-supply rejection ratio typical value in <i>Electrical Characteristics: THS4021 (D Package)</i>
•	Changed title of <i>Electrical Characteristics</i> to <i>Electrical Characteristics</i> : THS4021 (D Package) and THS4022 (D and DGN Packages)
•	Added Typical Characteristics: THS4021 (D Package) section

•	Changed title of Typical Characteristics to Typical Characteristics: THS4021 (D Pacakge) and THS4022 and DGN Packages)N	
•		
•	Deleted Noise Calculation and Noise Figure and Offset Voltage sections	
•	Changed device label from "THS402x" to "THS4021" in Figure 7-4	23
•	Changed Application Information section to latest standard format	24
•	Added Power Supply Recommendations section	25
•	Changed title of Circuit Layout Considerations section to Layout Guidelines, updated content, and move	d to
	Layout section	25
•	Deleted thermal calculations and plots from General PowerPAD™ Integrated Circuit Package Design	
	Considerations	26
•	Deleted Evaluation Board section	26

The datasheet number will be changing.

Device Family	Change From:	Change To:
THS402x	SLOS265C	SLOS265D

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/THS4021

**Reason for Change:** 

To accurately reflect device characteristics.

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

Electrical specification performance changes as indicated above.

Changes to product identification resulting from this PCN:

None.

Product Affected:			
THS4021CD	THS4021CDGN	THS4021CDGNR	THS4021ID
THS4021IDGN	THS4021IDGNR	THS4021IDR	THS4022CD
THS4022CDGN	THS4022CDGNR	THS4022ID	THS4022IDGN
THS4022IDGNR			

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN ww admin team@list.ti.com

## **IMPORTANT NOTICE AND DISCLAIMER**

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

## TI's products are provided subject to TI's Terms of Sale

(<u>www.ti.com/legal/termsofsale.html</u>) or other applicable terms available either on <u>ti.com</u> or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.